

Serial No. 10/564,336
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Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

[1] (currently amended) A phosphorus-containing silazane composition comprising a polyalkylsilazane and at least one phosphorus compound in an organic solvent wherein said phosphorus compound is ~~selected from a compound of formula (RO)₃P=O where each R, which may be the same or different, represents a trisubstituted silyl group in which the substituents have 1 to 4 carbon atoms or a compound of formula -R¹₂P=N- where each R¹, which may be the same or different, represents an alkoxy group having 1 to 5 carbon atoms tris(trimethylsilyl)phosphate.~~

Claims [2] to [11] (canceled)

[12] (currently amended) A semiconductor device comprising a phosphorus-containing siliceous film comprising 0.5 to 10 atomic% of phosphorus and being produced by baking a film of a phosphorus-containing silazane composition comprising a polyalkylsilazane and at least one phosphorus compound in an organic solvent wherein said phosphorus compound is tris(trimethylsilyl)phosphate according to claim 8 as an interlayer insulation film.